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Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	416
Number of Logic Elements/Cells	4160
Total RAM Bits	53248
Number of I/O	93
Number of Gates	263000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep20k100cf144c7es

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

- Advanced interconnect structure
 - Copper interconnect for high performance
 - Four-level hierarchical FastTrack® interconnect structure providing fast, predictable interconnect delays
 - Dedicated carry chain that implements arithmetic functions such as fast adders, counters, and comparators (automatically used by software tools and megafunctions)
 - Dedicated cascade chain that implements high-speed, high-fan-in logic functions (automatically used by software tools and megafunctions)
 - Interleaved local interconnect allows one LE to drive 29 other LEs through the fast local interconnect

Advanced software support

- Software design support and automatic place-and-route provided by the Altera® QuartusTM II development system for Windows-based PCs, Sun SPARCstations, and HP 9000 Series 700/800 workstations
- Altera MegaCore[®] functions and Altera Megafunction Partners Program (AMPPSM) megafunctions optimized for APEX 20KC architecture available
- NativeLinkTM integration with popular synthesis, simulation, and timing analysis tools
- Quartus II SignalTap[®] embedded logic analyzer simplifies in-system design evaluation by giving access to internal nodes during device operation
- Supports popular revision-control software packages including PVCS, RCS, and SCCS

Table 3. APEX 20KC QFP &BGA Package Options & I/O Count Notes (1), (2)								
Device	144-Pin TQFP	208-Pin PQFP	240-Pin PQFP	356-Pin BGA	652-Pin BGA			
EP20K100C	92	151	183	246				
EP20K200C		136	168	271	376			
EP20K400C					488			
EP20K600C					488			
EP20K1000C					488			
EP20K1500C					488			

General Description

Similar to APEX 20K and APEX 20KE devices, APEX 20KC devices offer the MultiCore architecture, which combines the strengths of LUT-based and product-term-based devices with an enhanced memory structure. LUT-based logic provides optimized performance and efficiency for datapath, register-intensive, mathematical, or digital signal processing (DSP) designs. Product-term-based logic is optimized for complex combinatorial paths, such as complex state machines. LUT- and product-term-based logic combined with memory functions and a wide variety of MegaCore and AMPP functions make the APEX 20KC architecture uniquely suited for SOPC designs. Applications historically requiring a combination of LUT-, product-term-, and memory-based devices can now be integrated into one APEX 20KC device.

APEX 20KC devices include additional features such as enhanced I/O standard support, CAM, additional global clocks, and enhanced ClockLock clock circuitry. Table 7 shows the features included in APEX 20KC devices.

Table 7. APEX 20KC Device Features (Part 1 of 2)						
Feature	APEX 20KC Devices					
MultiCore system integration	Full support					
Hot-socketing support	Full support					
SignalTap logic analysis	Full support					
32-/64-bit, 33-MHz PCI	Full compliance					
32-/64-bit, 66-MHz PCI	Full compliance in -7 speed grade					
MultiVolt I/O	1.8-V, 2.5-V, or 3.3-V V _{CCIO} V _{CCIO} selected bank by bank 5.0-V tolerant with use of external resistor					
ClockLock support	Clock delay reduction m/(n × v) clock multiplication Drive ClockLock output off-chip External clock feedback ClockShift circuitry LVDS support Up to four PLLs ClockShift, clock phase adjustment					
Dedicated clock and input pins	Eight					

The LAB-wide control signals can be generated from the LAB local interconnect, global signals, and dedicated clock pins. The inherent low skew of the FastTrack interconnect enables it to be used for clock distribution. Figure 4 shows the LAB control signal generation circuit.

Dedicated Clocks Global Signals Local Interconnect Local Interconnect Local Interconnect Interconnect LABCLR1 (1) **SYNCLOAD** LABCLKENA1 or LABCLKENA2 SYNCCLR LABCLK1 LABCLR2 (1) or LABCLK2 (2)

Figure 4. LAB Control Signal Generation

Notes:

- The LABCLR1 and LABCLR2 signals also control asynchronous load and asynchronous preset for LEs within the LAB.
- (2) The SYNCCLR signal can be generated by the local interconnect or global signals.

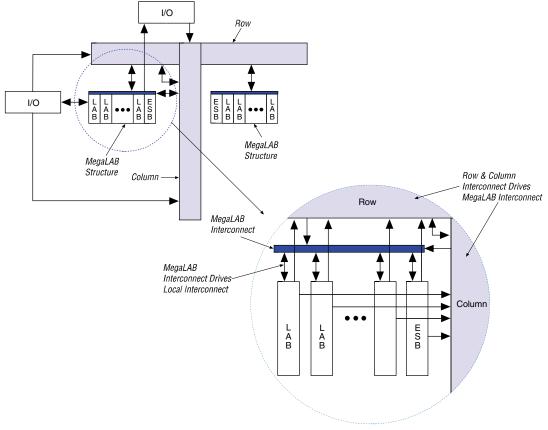
Logic Element

The LE, the smallest unit of logic in the APEX 20KC architecture, is compact and provides efficient logic usage. Each LE contains a four-input LUT, which is a function generator that can quickly implement any function of four variables. In addition, each LE contains a programmable register and carry and cascade chains. Each LE drives the local interconnect, MegaLAB interconnect, and FastTrack interconnect routing structures. See Figure 5.

Register a1 LUT b1 Carry Chain LE1 a2 Register ► s2 LUT b2 Carry Chain LE2 Register LUT an b*n* Carry Chain LE*n* Register ➤ Carry-Out LUT Carry Chain LE*n* + 1

Figure 6. APEX 20KC Carry Chain

Figure 10. FastTrack Connection to Local Interconnect



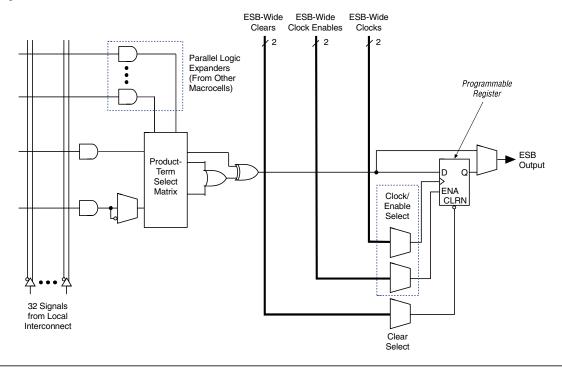
Source	Destination										
	Row I/O Pin	Column I/O Pin	LE	ESB	Local Interconnect	MegaLAB Interconnect	Row FastTrack Interconnect	Column FastTrack Interconnect	FastRow Interconnect		
Row I/O pin					✓	✓	✓	✓			
Column I/O pin					✓			✓	✓		
LE					✓	✓	✓	✓			
ESB					✓	✓	✓	✓			
Local interconnect	✓	✓	✓	✓							
MegaLAB interconnect					✓						
Row FastTrack interconnect						√		✓			
Column FastTrack interconnect						√	√				
FastRow interconnect					✓						

Product-Term Logic

The product-term portion of the MultiCore architecture is implemented with the ESB. The ESB can be configured to act as a block of macrocells on an ESB-by-ESB basis. Each ESB is fed by 32 inputs from the adjacent local interconnect; therefore, it can be driven by the MegaLAB interconnect or the adjacent LAB. Also, nine ESB macrocells feed back into the ESB through the local interconnect for higher performance. Dedicated clock pins, global signals, and additional inputs from the local interconnect drive the ESB control signals.

In product-term mode, each ESB contains 16 macrocells. Each macrocell consists of two product terms and a programmable register. Figure 13 shows the ESB in product-term mode.

Figure 14. APEX 20KC Macrocell



For registered functions, each macrocell register can be programmed individually to implement D, T, JK, or SR operation with programmable clock control. The register can be bypassed for combinatorial operation. During design entry, the designer specifies the desired register type; the Quartus II software then selects the most efficient register operation for each registered function to optimize resource utilization. The Quartus II software or other synthesis tools can also select the most efficient register operation automatically when synthesizing HDL designs.

Each programmable register can be clocked by one of two ESB-wide clocks. The ESB-wide clocks can be generated from device dedicated clock pins, global signals, or local interconnect. Each clock also has an associated clock enable, generated from the local interconnect. The clock and clock enable signals are related for a particular ESB; any macrocell using a clock also uses the associated clock enable.

If both the rising and falling edges of a clock are used in an ESB, both ESB-wide clock signals are used.

ESBs can implement synchronous RAM, which is easier to use than asynchronous RAM. A circuit using asynchronous RAM must generate the RAM write enable (WE) signal, while ensuring that its data and address signals meet setup and hold time specifications relative to the WE signal. In contrast, the ESB's synchronous RAM generates its own WE signal and is self-timed with respect to the global clock. Circuits using the ESB's self-timed RAM must only meet the setup and hold time specifications of the global clock.

ESB inputs are driven by the adjacent local interconnect, which in turn can be driven by the FastTrack or MegaLAB interconnect. Because the ESB can be driven by the local interconnect, an adjacent LE can drive it directly for fast memory access. ESB outputs drive the FastTrack and MegaLAB interconnects. In addition, ten ESB outputs, nine of which are unique output lines, drive the local interconnect for fast connection to adjacent LEs or for fast feedback product-term logic.

When implementing memory, each ESB can be configured in any of the following sizes: 128×16 , 256×8 , 512×4 , $1,024 \times 2$, or $2,048 \times 1$. By combining multiple ESBs, the Quartus II software implements larger memory blocks automatically. For example, two 128×16 RAM blocks can be combined to form a 128×32 RAM block, and two 512×4 RAM blocks can be combined to form a 512×8 RAM block. Memory performance does not degrade for memory blocks up to 2,048 words deep. Each ESB can implement a 2,048-word-deep memory; the ESBs are used in parallel, eliminating the need for any external control logic and its associated delays.

To create a high-speed memory block that is more than 2,048 words deep, ESBs drive tri-state lines. Each tri-state line connects all ESBs in a column of MegaLAB structures, and drives the MegaLAB interconnect and row and column FastTrack interconnect throughout the column. Each ESB incorporates a programmable decoder to activate the tri-state driver appropriately. For instance, to implement 8,192-word-deep memory, four ESBs are used. Eleven address lines drive the ESB memory, and two more drive the tri-state decoder. Depending on which 2,048-word memory page is selected, the appropriate ESB driver is turned on, driving the output to the tri-state line. The Quartus II software automatically combines ESBs with tri-state lines to form deeper memory blocks. The internal tri-state control logic is designed to avoid internal contention and floating lines. See Figure 18.

Input/Output Clock Mode

The input/output clock mode contains two clocks. One clock controls all registers for inputs into the ESB: data input, WE, RE, read address, and write address. The other clock controls the ESB data output registers. The ESB also supports clock enable and asynchronous clear signals; these signals also control the reading and writing of registers independently. Input/output clock mode is commonly used for applications where the reads and writes occur at the same system frequency, but require different clock enable signals for the input and output registers. Figure 21 shows the ESB in input/output clock mode.

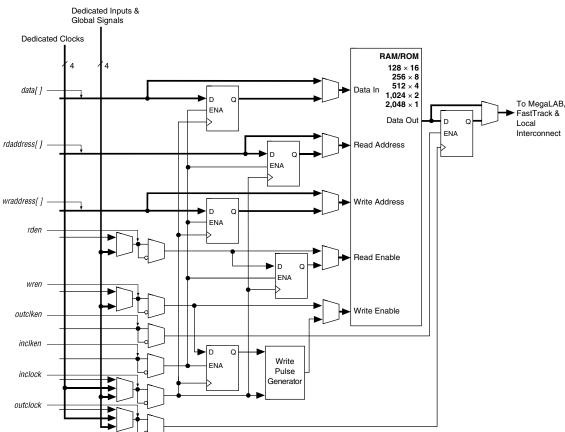


Figure 21. ESB in Input/Output Clock Mode Note (1)

Note:

(1) All registers can be cleared asynchronously by ESB local interconnect signals, global signals, or the chip-wide reset.

Implementing Logic in ROM

In addition to implementing logic with product terms, the ESB can implement logic functions when it is programmed with a read-only pattern during configuration, creating a large LUT. With LUTs, combinatorial functions are implemented by looking up the results, rather than by computing them. This implementation of combinatorial functions can be faster than using algorithms implemented in general logic, a performance advantage that is further enhanced by the fast access times of ESBs. The large capacity of ESBs enables designers to implement complex functions in one logic level without the routing delays associated with linked LEs or distributed RAM blocks. Parameterized functions such as LPM functions can take advantage of the ESB automatically. Further, the Quartus II software can implement portions of a design with ESBs where appropriate.

Programmable Speed/Power Control

APEX 20KC ESBs offer a high-speed mode that supports very fast operation on an ESB-by-ESB basis. When high speed is not required, this feature can be turned off to reduce the ESB's power dissipation by up to 50%. ESBs that run at low power incur a nominal timing delay adder. This Turbo BitTM option is available for ESBs that implement product-term logic or memory functions. An ESB that is not used will be powered down so that it does not consume DC current.

Designers can program each ESB in the APEX 20KC device for either high-speed or low-power operation. As a result, speed-critical paths in the design can run at high speed, while the remaining paths operate at reduced power.

I/O Structure

The APEX 20KC IOE contains a bidirectional I/O buffer and a register that can be used either as an input register for external data requiring fast setup times or as an output register for data requiring fast clock-to-output performance. IOEs can be used as input, output, or bidirectional pins.

APEX 20KC devices include an enhanced IOE, which drives the FastRow interconnect. The FastRow interconnect connects a column I/O pin directly to the LAB local interconnect within two MegaLAB structures. This feature provides fast setup times for pins that drive high fan-outs with complex logic, such as PCI designs. For fast bidirectional I/O timing, LE registers using local routing can improve setup times and OE timing. The APEX 20KC IOE also includes direct support for open-drain operation, giving faster clock-to-output for open-drain signals. Some programmable delays in the APEX 20KC IOE offer multiple levels of delay to fine-tune setup and hold time requirements. The Quartus II Compiler sets these delays by default to minimize setup time while providing a zero hold time.

Signals can be driven into APEX 20KC devices before and during power-up without damaging the device. In addition, APEX 20KC devices do not drive out during power-up. Once operating conditions are reached and the device is configured, APEX 20KC devices operate as specified by the user.

MultiVolt I/O Interface

The APEX architecture supports the MultiVolt I/O interface feature, which allows APEX devices in all packages to interface with systems of different supply voltages. The devices have one set of VCC pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

APEX 20KC devices support the MultiVolt I/O interface feature. The APEX 20KC VCCINT pins must always be connected to a 1.8-V power supply. With a 1.8-V V_{CCINT} level, input pins are 1.8-V, 2.5-V, and 3.3-V tolerant. The VCCIO pins can be connected to either a 1.8-V, 2.5-V, or 3.3-V power supply, depending on the I/O standard requirements. When the VCCIO pins are connected to a 1.8-V power supply, the output levels are compatible with 1.8-V systems. When VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When VCCIO pins are connected to a 3.3-V power supply, the output high is 3.3 V and compatible with 3.3-V or 5.0-V systems. An APEX 20KC device is 5.0-V tolerant with the addition of a resistor.

Table	10	summarizes	APEX	20KC	Multi\	/olt I/C) suppo	ort.
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Table 10. APEX 20KC MultiVolt I/O Support									
V _{CCIO} (V) Input Signals (V) Output Signals (V)									
	1.8	2.5	3.3	5.0	1.8	2.5	3.3	5.0	
1.8	✓	√ (1)	√ (1)		✓				
2.5		✓	√ (1)			✓			
3.3		✓	✓	√ (2)		√ (3)	✓	✓	

Notes:

- The PCI clamping diode must be disabled to drive an input with voltages higher than V_{CCIO}, except for the 5.0-V input case.
- (2) An APEX 20KC device can be made 5.0-V tolerant with the addition of an external resistor.
- (3) When $V_{CCIO} = 3.3 \text{ V}$, an APEX 20KC device can drive a 2.5-V device with 3.3-V tolerant inputs.

Open-drain output pins on APEX 20KC devices (with a series resistor and a pull-up resistor to the 5.0-V supply) can drive 5.0-V CMOS input pins that require a V_{IH} of 3.5 V. When the pin is inactive, the trace will be pulled up to 5.0 V by the resistor. The open-drain pin will only drive low or tri-state; it will never drive high. The rise time is dependent on the value of the pull-up resistor and load impedance. The I_{OL} current specification should be considered when selecting a pull-up resistor.

ClockLock & ClockBoost Features

APEX 20KC devices support the ClockLock and ClockBoost clock management features, which are implemented with PLLs. The ClockLock circuitry uses a synchronizing PLL that reduces the clock delay and skew within a device. This reduction minimizes clock-to-output and setup times while maintaining zero hold times. The ClockBoost circuitry, which provides a clock multiplier, allows the designer to enhance device area efficiency by sharing resources within the device. The ClockBoost circuitry allows the designer to distribute a low-speed clock and multiply that clock on-device. APEX 20KC devices include a high-speed clock tree; unlike ASICs, the user does not have to design and optimize the clock tree. The ClockLock and ClockBoost features work in conjunction with the APEX 20KC device's high-speed clock to provide significant improvements in system performance and bandwidth. APEX 20KC devices in -7 and -8 speed grades include the ClockLock feature.

The ClockLock and ClockBoost features in APEX 20KC devices are enabled through the Quartus II software. External devices are not required to use these features.

APEX 20KC ClockLock Feature

APEX 20KC devices include up to four PLLs, which can be used independently. Two PLLs are designed for either general-purpose use or LVDS use (on devices that support LVDS I/O pins). The remaining two PLLs are designed for general-purpose use. The EP20K100C and EP20K200C devices have two PLLs; the EP20K400C and larger devices have four PLLs.

The following sections describe some of the features offered by the APEX 20KC PLLs.

External PLL Feedback

The ClockLock circuit's output can be driven off-chip to clock other devices in the system; further, the feedback loop of the PLL can be routed off-chip. This feature allows the designer to exercise fine control over the I/O interface between the APEX 20KC device and another high-speed device, such as SDRAM.

Table 12. Al	PEX 20KC Clock Input & Outpu	ut Parameters (Pa	rt 2 of 2)	Note (1)		
Symbol	Parameter	I/O Standard	-7 Spee	ed Grade	-8 Spee	d Grade	Units
			Min	Max	Min	Max	
f _{CLOCK1_EXT}	Output clock frequency for	3.3-V LVTTL	(5)	(5)	(5)	(5)	MHz
	external clock1 output	2.5-V LVTTL	(5)	(5)	(5)	(5)	MHz
		1.8-V LVTTL	(5)	(5)	(5)	(5)	MHz
		GTL+	(5)	(5)	(5)	(5)	MHz
		SSTL-2 Class I	(5)	(5)	(5)	(5)	MHz
		SSTL-2 Class II	(5)	(5)	(5)	(5)	MHz
		SSTL-3 Class I	(5)	(5)	(5)	(5)	MHz
		SSTL-3 Class II	(5)	(5)	(5)	(5)	MHz
		LVDS	(5)	(5)	(5)	(5)	MHz
f _{IN}	Input clock frequency	3.3-V LVTTL	(5)	(5)	(5)	(5)	MHz
		2.5-V LVTTL	(5)	(5)	(5)	(5)	MHz
		1.8-V LVTTL	(5)	(5)	(5)	(5)	MHz
		GTL+	(5)	(5)	(5)	(5)	MHz
		SSTL-2 Class I	(5)	(5)	(5)	(5)	MHz
		SSTL-2 Class II	(5)	(5)	(5)	(5)	MHz
		SSTL-3 Class I	(5)	(5)	(5)	(5)	MHz
		SSTL-3 Class II	(5)	(5)	(5)	(5)	MHz
		LVDS	(5)	(5)	(5)	(5)	MHz

Notes to tables:

- (1) All input clock specifications must be met. The PLL may not lock onto an incoming clock if the clock specifications are not met, creating an erroneous clock within the device.
- (2) The maximum lock time is 40 µs or 2,000 input clock cycles, whichever occurs first.
- (3) Before configuration, the PLL circuits are disable and powered down. During configuration, the PLLs remain disabled. The PLLs begin to lock once the device is in the user mode. If the clock enable feature is used, lock begins once the CLKLK_ENA pin goes high in user mode.
- (4) The PLL VCO operating range is 200 MHz $\leq f_{VCO} \leq$ 840 MHz for LVDS mode.
- (5) Contact Altera Applications for information on these parameters.

SignalTap Embedded Logic Analyzer

APEX 20KC devices include device enhancements to support the SignalTap embedded logic analyzer. By including this circuitry, the APEX 20KC device provides the ability to monitor design operation over a period of time through the IEEE Std. 1149.1 (JTAG) circuitry; a designer can analyze internal logic at speed without bringing internal signals to the I/O pins. This feature is particularly important for advanced packages such as FineLine BGA packages because adding a connection to a pin during the debugging process can be difficult after a board is designed and manufactured.

Table 28. G	Table 28. GTL+ I/O Specifications									
Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units				
V _{TT}	Termination voltage		1.35	1.5	1.65	V				
V_{REF}	Reference voltage		0.88	1.0	1.12	V				
V _{IH}	High-level input voltage		V _{REF} + 0.1			V				
V _{IL}	Low-level input voltage				V _{REF} – 0.1	V				
V _{OL}	Low-level output voltage	I _{OL} = 36 mA (2)			0.65	V				

Table 29. SS	Table 29. SSTL-2 Class I Specifications								
Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units			
V _{CCIO}	I/O supply voltage		2.375	2.5	2.625	٧			
V _{TT}	Termination voltage		V _{REF} - 0.04	V _{REF}	V _{REF} + 0.04	V			
V _{REF}	Reference voltage		1.15	1.25	1.35	٧			
V _{IH}	High-level input voltage		V _{REF} + 0.18		V _{CCIO} + 0.3	V			
V _{IL}	Low-level input voltage		-0.3		V _{REF} – 0.18	V			
V _{OH}	High-level output voltage	$I_{OH} = -7.6 \text{ mA} (1)$	V _{TT} + 0.57			V			
V _{OL}	Low-level output voltage	I _{OL} = 7.6 mA (2)			V _{TT} – 0.57	V			

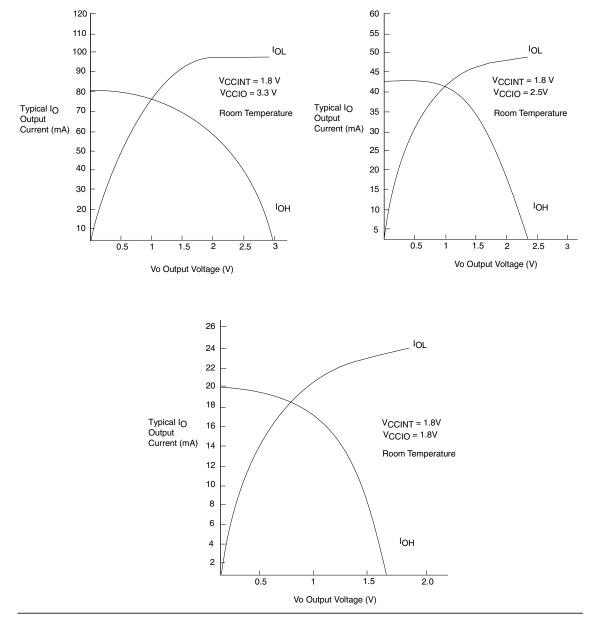


Figure 32. Output Drive Characteristics of APEX 20KC Devices

Timing Model

The high-performance FastTrack and MegaLAB interconnect routing resources ensure predictable performance, accurate simulation, and accurate timing analysis. This predictable performance contrasts with that of FPGAs, which use a segmented connection scheme and therefore have unpredictable performance.

Figure 33 shows the $f_{M\!A\!X}$ timing model for APEX 20KC devices.

Figure 33. f_{MAX} Timing Model LE ^tsu Routing Delay $^{t}_{H}$ ^t F1—4 ^tco ^t F5—20 ^t LUT t F20+ ESB ^tESBARC ESBSRC ^tESBAWC ^tESBSWC ^tESBWASU ESBWDSU ^tESBSRASU ^tESBWESU ^tESBDATASU ^tESBWADDRSU ^t.ESBRADDRSU ^tESBDATACO1 ^tESBDATACO2 ^tESBDD ^tPD

Figure 34 shows the timing model for bidirectional I/O pin timing.

^tPTERMSU ^tPTERMCO

Table 42. APEX 20KC External Bidirectional Timing Parameters Note (1)							
Symbol	Parameter	Condition					
t _{INSUBIDIR}	Setup time for bidirectional pins with global clock at LAB-adjacent input register						
t _{INHBIDIR}	Hold time for bidirectional pins with global clock at LAB-adjacent input register						
^t OUTCOBIDIR	Clock-to-output delay for bidirectional pins with global clock at IOE register	C1 = 35 pF					
t _{XZBIDIR}	Synchronous output enable register to output buffer disable delay	C1 = 35 pF					
t _{ZXBIDIR}	Synchronous output enable register to output buffer enable delay	C1 = 35 pF					
^t INSUBIDIRPLL	Setup time for bidirectional pins with PLL clock at LAB-adjacent input register						
t _{INHBIDIRPLL}	Hold time for bidirectional pins with PLL clock at LAB-adjacent input register						
†OUTCOBIDIRPLL	Clock-to-output delay for bidirectional pins with PLL clock at IOE register	C1 = 35 pF					
t _{XZBIDIRPLL}	Synchronous output enable register to output buffer disable delay with PLL	C1 = 35 pF					
t _{ZXBIDIRPLL}	Synchronous output enable register to output buffer enable delay with PLL	C1 = 35 pF					

Note to tables:
(1) These timing parameters are sample-tested only.

Symbol	-7 Spee	d Grade	-8 Speed Grade (2)		-9 Speed Grade (2)		Unit
	Min	Max	Min	Max	Min	Max	
t _{CH}	2.0						ns
t_{CL}	2.0						ns
t _{CLRP}	0.2						ns
t _{PREP}	0.2						ns
t _{ESBCH}	2.0						ns
t _{ESBCL}	2.0						ns
t _{ESBWP}	1.0						ns
t _{ESBRP}	0.8						ns

Table 71. EP20K1000C External Timing Parameters								
Symbol	-7 Speed Grade		-8 Speed Grade (2)		-9 Speed Grade (2)		Unit	
	Min	Max	Min	Max	Min	Max		
t _{INSU}	2.1						ns	
t _{INH}	0.0						ns	
t _{оитсо}	2.0	5.0					ns	
t _{INSUPLL}	3.2						ns	
t _{INHPLL}	0.0						ns	
toutcopll	0.5	2.1					ns	

Table 79. Selectable I/O Standard Input Delays							
Symbol	-7 Speed Grade		-8 Speed Grade (1)		-9 Speed Grade (1)		Unit
	Min	Max	Min	Max	Min	Max	Min
LVCMOS		0.0					ns
LVTTL		0.0					ns
2.5 V		0.1					ns
1.8 V		0.5					ns
PCI		0.4					ns
GTL+		-0.3					ns
SSTL-3 Class I		-0.4					ns
SSTL-3 Class II		-0.4					ns
SSTL-2 Class I		-0.3					ns
SSTL-2 Class II		-0.3					ns
LVDS		-0.2					ns
СТТ		-0.3					ns
AGP		0.0					ns

Table 80. Selectable I/O Standard Output Delays							
Symbol	-7 Speed Grade		-8 Speed Grade (1)		-9 Speed Grade (1)		Unit
	Min	Max	Min	Max	Min	Max	Min
LVCMOS		0.0					ns
LVTTL		0.0					ns
2.5 V		0.5					ns
1.8 V		1.7					ns
PCI		-0.2					ns
GTL+		-0.4					ns
SSTL-3 Class I		-0.1					ns
SSTL-3 Class II		-0.6					ns
SSTL-2 Class I		0.0					ns
SSTL-2 Class II		-0.4					ns
LVDS		-0.8					ns
CTT		-0.2					ns
AGP		-0.4					ns

Note to tables:

 $(1) \quad \mbox{Timing information will be released in a future version of this data sheet.}$

Multiple APEX 20KC devices can be configured in any of five configuration schemes by connecting the configuration enable (nCE) and configuration enable output (nCEO) pins on each device.

Table 81. Data Sources for Configuration				
Configuration Scheme	Data Source			
Configuration device	EPC16, EPC2, or EPC1 configuration device			
Passive serial (PS)	MasterBlaster or ByteBlasterMV download cable or serial data source			
Passive parallel asynchronous (PPA)	Parallel data source			
Passive parallel synchronous (PPS)	Parallel data source			
JTAG	MasterBlaster or ByteBlasterMV download cable or a microprocessor with a Jam Standard Test and Programming Language (STAPL) or JBC File			



For more information on configuration, see *Application Note 116* (*Configuring APEX 20K, FLEX 10K & FLEX 6000 Devices.*)

Device Pin-Outs

See the Altera web site (http://www.altera.com) or the *Altera Digital Library* for pin-out information.

Revision History

The information contained in the *APEX 20KC Programmable Logic Device Data Sheet* version 1.1 supersedes information published in pervious versions.

The following changes were made to the *APEX 20KC Programmable Logic Device Data Sheet* version 1.1: updated maximum user I/O pins in Table 1.